

Part Search updated

L Number	Hits	Search Text	DB	Time stamp
1	2	6161276.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 13:27
2	2	5829121.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:00
3	7	("4038742" "4120085" "4160220" "4546357" "4706051" "5307556" "5592150").PN.	USPAT	2004/11/02 13:31
4	3	4135020.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:03
5	716	stencil and holes and segments	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:14
6	0	stencil and annular near holes and segments	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:08
7	3	stencil and annular near holes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:09
8	13	("2825143" "2920509" "4057898" "4199060" "4952101" "5056966" "5064319" "5116170" "5375949" "5383281" "5392524" "5569001" "5666737").PN.	USPAT	2004/11/02 15:09
9	2	6662440.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:10
10	10	("3941636" "4126727" "4648179" "5068714" "5415555" "5669970" "5740730" "5866951" "6118080" "6162856").PN.	USPAT	2004/11/02 15:10
11	10	("3680037" "3971610" "4184729" "4808112" "5342207" "5415555" "5744758" "5767580" "5866951" "5902606").PN.	USPAT	2004/11/02 15:11

12	2	("Re34615" "5522929").PN.	USPAT	2004/11/02 15:13
13	15	("3292240" "3303393" "3517279" "3795047" "4069791" "4157407" "4164005" "4172547" "4234626" "4411980" "4469777" "4572764" "4667401" "4720740" "4868637").PN.	USPAT	2004/11/02 15:13
14	0	stencil and opening near spokes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:15
15	264	opening near spokes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:15
16	0	opening near spokes and template	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:15
17	418	spokes and template	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:16
18	0	(template, stencil) with holes near spokes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:17
19	0	(template, stencil) and holes near spokes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:17
20	0	template and holes near spokes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:17
21	411	hole near spokes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:18
22	0	hole near spokes and stencil	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:18

23	105	hole near spokes and plate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:18
24	2	solder and paste and hole near segment and plate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:19
25	5	solder adj template and hole	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:20
26	0	solder adj template and opening near pokes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:20
27	0	solder adj template and opening and spokes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:20
28	150	template and opening and spokes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:24
29	136	stencil and opening and depositing near material	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:31
30	2	("5656093" "5863396").PN.	USPAT	2004/11/02 15:27
31	19	("4184188" "4361643" "4384918" "4502094" "4599970" "4603466" "5117121" "5192371" "5376180" "5382311" "5447595" "5456756" "5463526" "5474614" "5528451" "5530616" "5531835" "5560780" "5583736").PN.	USPAT	2004/11/02 15:28
32	0	stencil and annular near hole and depositing near material	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:31
33	3	stencil and annular near hole	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:37

34	13	("2825143" "2920509" "4057898" "4199060" "4952101" "5056966" "5064319" "5116170" "5375949" "5383281" "5392524" "5569001" "5666737").PN.	USPAT	2004/11/02 15:32
35	20	("2187087" "2507684" "2932897" "3621579" "3664026" "3936944" "4149320" "4351113" "4367590" "4425391" "4708755" "4750270" "4827621" "4845858" "4942670" "4965943" "4970797" "5012590" "5107601" "5255207").PN.	USPAT	2004/11/02 15:36
36	0	soldering near (stencil, template, mask) and annular near hole	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:37
37	4	solder near (stencil, template, mask) and annular near hole	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:47
38	14	("3360852" "3530229" "4616292" "4884170" "5133495" "5148265" "5148266" "5400220" "5519580" "5585162" "5590460" "5766987" "5801446" "5818697").PN.	USPAT	2004/11/02 15:42
39	1	solder near (stencil, template, mask) and annular near hole and (174/260; 174/261 ; 174/250 ; 174/262 ; 174/266 ; 174/256; 174/257 ; 174/258 ; 361/748 ; 361/767 ; 361/768 ; 361/771 ; 361/779 ; 361/780 ; 361/794).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:51
40	0	solder near (stencil, template, mask) and annular near hole and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:51
41	500	solder near (stencil, template, mask) and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:52
42	385	solder near (stencil, template, mask)and holes and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:52

43	5722	solder near (stencil, template, mask) and annular near hole and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:52
44	0	solder near (stencil, template, mask) and annular near hole and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:52
45	0	solder near (stencil, template, mask) and opening and non adj wettable near portion and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:53
46	242	solder near (stencil, template, mask) and opening and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:54
47	242	solder near (stencil, template, mask) and opening and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:54
48	14	("4716049" "4813129" "4902606" "5055907" "5072520" "5163834" "5180311" "5192716" "5194930" "5203076" "5249101" "5299939" "5329423" "5430614").PN.	USPAT	2004/11/02 16:00